

# **SWITCHING DIODE**

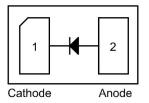
## **Features and benefits**

- Extremely small surface mounting type.
- High Speed.

# **Application information**

· High speed switching

### **Schematic & Pin configuration**



## **Ordering information**

Device	Package	Packaging	
1N4148DNG2	DFN1006-2	10000/Tape & Reel	

## Maximum Ratings (T<sub>A</sub> = 25 °C, unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak reverse voltage	V <sub>RM</sub>	90	V
DC reverse voltage	$V_R$	80	V
Peak forward current	I <sub>FM</sub>	225	mA
Mean rectifying current	Io	100	mA
Surge current (1s)	I <sub>SURGE</sub>	500	mA
Junction temperature	T <sub>j</sub>	125	°C
Storage temperature	$T_{stg}$	-40 to +125	°C

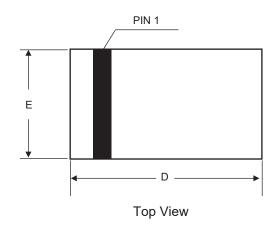
# **Electrical Characteristics** (T<sub>A</sub> = 25 °C, unless otherwise specified)

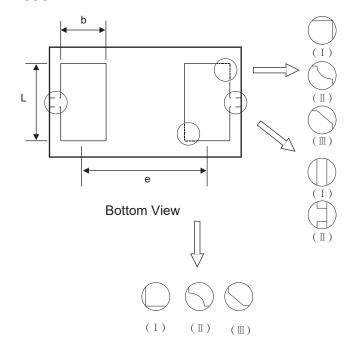
Characteristic	Symbol	Max	Unit
Forward voltage (I <sub>F</sub> =100mA)	V <sub>F</sub>	1.2	V
Reverse current (V <sub>R</sub> =80V)	I <sub>R</sub>	0.1	uA
Capacitance between terminals (V <sub>R</sub> =0.5V,f=1MHz)	Ст	3	pF
Reverse recovery time $(V_R=6V,I_F=10mA,R_L=100\Omega)$	T <sub>rr</sub>	4	nS

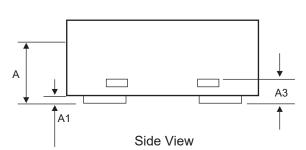


## **PACKAGE OUTLINE DIMENSIONS**

### **DFN1006-2**

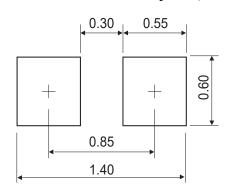






Symbol	D	Dimensions in Millimeters		
	Min.	Тур.	Max.	
А	0.340	0.450	0.530	
A1	0.000	0.020	0.050	
A3		0.125 Ref.		
D	0.950	1.000	1.075	
Е	0.550	0.600	0.675	
b	0.200	0.250	0.300	
L	0.450	0.500	0.550	
е		0.650 BSC		

## Recommended PCB Layout (Unit: mm)



### Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.